

**UNITED STATES DISTRICT COURT
NORTHERN DISTRICT OF CALIFORNIA
SAN FRANCISCO DIVISION**

HUAWEI TECHNOLOGIES CO., LTD.,
HUAWEI DEVICE USA, INC., and
HUAWEI TECHNOLOGIES USA, INC.,

Plaintiffs / Counterclaim-
Defendants,

v.

SAMSUNG ELECTRONICS CO., LTD.,
SAMSUNG ELECTRONICS AMERICA,
INC.,

Defendants / Counterclaim-
Plaintiffs,

and

SAMSUNG RESEARCH AMERICA,

Defendant,

v.

HISILICON TECHNOLOGIES CO., LTD.,

Counterclaim-Defendant.

Case No. 3:16-cv-2787-WHO

**JOINT CASE MANAGEMENT
CONFERENCE STATEMENT**

Date: May 4, 2018

Time: 2:00 p.m.

Dept.: Courtroom G, 15th Floor

Judge: Honorable Joseph C. Spero

Trial Date: December 3, 2018

Pursuant to the Court's Order of January 22, 2018 (Dkt. 228), Federal Rule of Civil Procedure 26(f), Civil Local Rule 16-9(a), and the Standing Order for All Judges of the Northern District of California – Contents of Joint Case Management Statement, Plaintiffs/Counterclaim-Defendants Huawei Technologies Co., Ltd., Huawei Device USA, Inc., and Huawei Technologies USA, Inc., and Counterclaim-Defendant Hi-Silicon Technologies Co. Ltd. (collectively, "Huawei") and Defendants/Counterclaim-Plaintiffs Samsung Electronics Co., Ltd., and Samsung Electronics America, Inc., and Defendant Samsung Research America (collectively "Samsung") jointly submit this Case Management Statement.

At this time, the parties do not have any specific issues to address at the May 4, 2018 case management conference, but will be prepared to discuss the current status of the case.

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1 **I. ADDITIONAL INFORMATION REQUIRED BY THE DISTRICT'S STANDING**
2 **ORDER**

3 The parties previously submitted a Joint Case Management Conference Statement (Dkt. 67)
4 that includes additional information required by the District's Standing Order, such as the basis for
5 jurisdiction, the factual background for this case, and the principal disputed legal issues. The parties
6 update this information as follows:

7 Motions. Huawei's Rule 59(e) Motion to Alter or Amend the Court's April 13, 2018 Order
8 Granting Samsung's Motion for Antisuit Injunction (Dkt. 285) was filed on April 20, 2018.

9 Discovery Status. Fact discovery is largely complete. Expert discovery is ongoing.

1 Dated: April 27, 2018

Respectfully Submitted,

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By: /s/ Charles K. Verhoeven

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21 *Technologies USA, Inc., and HiSilicon*

22 *Technologies Co., Ltd.*

ATTESTATION

Pursuant to Civil Local Rule 5-1(i)(3), the filer of this document attests that concurrence in the filing of this document has been obtained from the other signatories above.

Dated: April 27, 2018

By: /s/ Michael J. Bettinger
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